

In the Claims

The following is a listing of the current state of the claims:

1. – 20. (Canceled)

21. (Previously Presented) A computer system comprising:

a memory having a magnetic tunnel junction (MTJ) memory device, the MTJ memory device having a memory cell;

a biasing circuit configured to supply at least two different biasing voltages to the cell;

a sensing circuit configured to measure the current flowing through the cell at each of the at least two different biasing voltages; and

a processing element configured to determine a ratio of the current flowing through the cell at a first one of the at least two different biasing voltages to the current flowing through the cell at a second one of the at least two different biasing voltages and to compare the ratio to a predetermined value.

22. (Previously Presented) The system of claim 21, wherein the biasing circuit, the sensing circuit, the processing element and the MTJ device are fabricated as an application specific integrated circuit (ASIC).

23. (Previously Presented) The system of claim 21, wherein the biasing circuit is a voltage supply.

24. (Previously Presented) The system of claim 21, wherein the sensing circuit is an ammeter.
25. (Previously Presented) The system of claim 21, further comprising a reference MTJ memory cell having a known state.
26. (Previously Presented) The system of claim 21, wherein the MTJ device is a magnetic random access memory (MRAM).
27. (Previously Presented) The system of claim 21, wherein the MRAM is an MRAM array.
28. (Previously Presented) The system of claim 21, wherein the second bias voltage is less than the first bias voltage.
29. (Previously Presented) The system of claim 21, wherein the second bias voltage is more than the first bias voltage.
30. (Previously Presented) The system of claim 21, wherein the second bias voltage is on the order of 1/3 of the first bias voltage.
31. (Previously Presented) The system of claim 21, further comprising a processor operative to execute instructions stored in said memory.

32. (Previously Presented) A method for determining the logic state of a memory cell in a magnetic tunnel junction (MTJ) memory device, comprising:

applying a first bias voltage to the cell;

measuring a current flowing through the cell at the first bias voltage;

applying a second bias voltage to the cell, the second bias voltage being different from the first bias voltage;

measuring a current flowing through the cell at the second bias voltage;

using the current flowing through the cell and measured at each of the first bias voltage and second bias voltage to determine the logic state of the cell.

33. (Previously Presented) The method of claim 32, wherein the second bias voltage is less than the first bias voltage.

34. (Previously Presented) The method of claim 32, wherein the second bias voltage is greater than the first bias voltage.

35. (Previously Presented) The method of claim 32, wherein the second bias voltage is on the order of 1/3 of the first bias voltage.

36. (Previously Presented) The method of claim 32, wherein the MTJ device is a magnetic random access memory (MRAM).

37. (Previously Presented) The method of claim 32, wherein the MRAM is an MRAM array.